

Practitioner's Docket No.: APA-0217

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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AUG 10 2005

In re Patent Application of:

Kazuya MAEKAWA, et al

Application No.: 10/509,895

Confirmation No.: 2978

Filed: October 01, 2004

Art Unit: 3724

For: MEHOD FOR SEVERING BRITTLE  
MATERIAL SUBSTRATE AND SEVERING  
APPARATUS USING THE METHOD

Examiner: Not Yet Assigned

Attention: Office of Initial Patent Examination's  
Customer Service CenterCommissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

## REQUEST FOR CORRECTED FILING RECEIPT

1. Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested. Also enclosed is a copy of the Japanese language Declaration.
2. There is an error with respect to the following, which is incorrectly entered.


**Error in****Correct data**

1. Title

1. Method for severing brittle material substrate and  
severing apparatus using the method

3. The correction is due to an error by the USPTO. If any fee is due, please charge Deposit Account No. 18-0013.

Dated: August 10, 2005

  
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